



Features Applications

- High Frequency
- · Low Phase Noise
- Low power consumption
- Output: True Sinewave
- Tight Tolerances
- Frequency range ¹ of 250 700 MHz
- Standard Frequencies: 256; 400; 500; 502 MHz

- Test & Measurement
- Communication Equipment
- Industrial
- Military

Performance Specifications

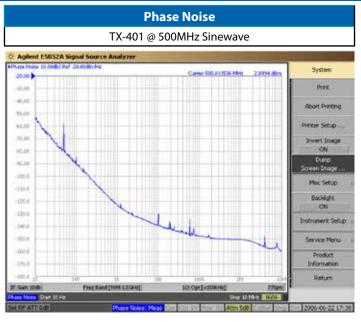
Frequency Stabilities ¹							
Parameter	Min	Typical	Max	Units	Condition		
vs. operating temperature range (referenced to +25°C)	-2 -1 -1		+2 +1 +1	ppm ppm ppm	-40 to +85°C -40 to +85°C -20 to +70°C	Options ³	
Initial tolerance vs. supply voltage change vs. load change vs. aging 10 years	-2 -0.8 -0.2 -4		+2 +0.8 +0.2 +4	ppm ppm ppm ppm	at time of shipment, nominal EF V _s ±5% static Load ±10% static after 30 days of operation	C	
		Sup	ply Voltage	(Vs)			
Supply voltage (Standard)	3.135	3.3	3.465	VDC			
Supply voltage (Option)	4.75	5	5.25	VDC			
Current consumption			75 50	mA mA	@3.3V @5V		
RF Output							
True Sinewave							
Load	45	50	55	Ohm			
Output Power	0	3	6	dBm			
Harmonics			-25	dBc			
Subharmonics			-40	dBc			

Performance Specifications

Frequency Tuning (EFC)							
Parameter	Min	Typical	Max	Units	Condition		
Tuning Range	Fixed TCXO; No adjust				Opti- on ⁵		
Tuning Range	±5		±18	ppm		Q o	
Linearity	<10%						
Tuning Slope	Positive						
Control Input Impedance	10			kOhm			
Control Voltage Range	0.3 0.5	1.65 2.5	3.0 4.5	VDC	Vs=3.3V Vs=5V		
	Additional Parameters						
Phase Noise ²		-54 -90 -122 -140 -147 -150 -160		dBc/Hz dBc/Hz dBc/Hz dBc/Hz dBc/Hz dBc/Hz dBc/Hz	10 Hz 100 Hz 1 kHz 10 kHz 100 kHz 1 MHz	@ 500MHz Sinewave 5V	
Jitter			0.1	ps RMS	@ 12 kHz to 20 MHz		
Weight			2.0	g			
Processing & Packing	ı	Handling & Pi	rocessing No	te			

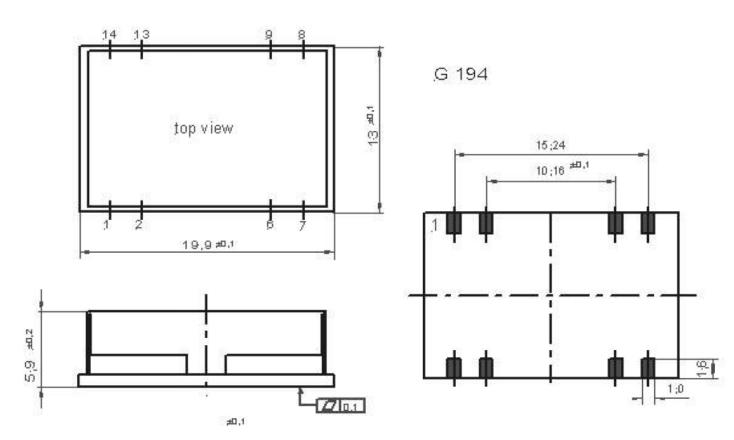
Absolute Maximum Ratings					
supply voltage (Vs)			6.0	V	
Operable Temperature Range	-40		+85	°C	
Storage Temperature Range	-40		+105	°C	

Typical Performance



Outline Drawing / Enclosure

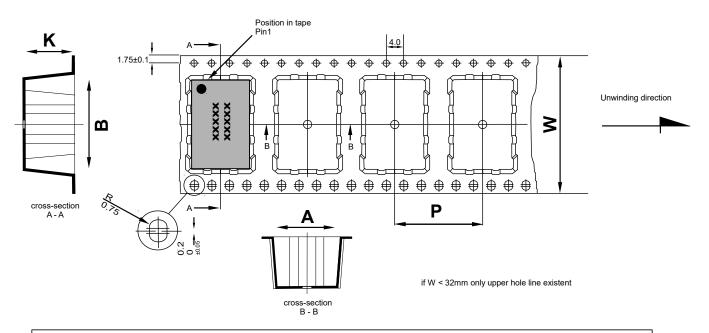
TX-401						
Type	Height "H"					
G194	5.9					



all units in mm

	Pin Connections					
1	Control Voltage Input (Vc) / N.C.					
2	N.C.					
6	GND (Case)					
7	GND (Case)					
8	RF-Output					
9	GND (Case)					
13	N.C.					
14	Supply Voltage Input (Vs)					

Standard Shipping Method (TX-401)



Dimension in mm:

A, B and K are dependent uppon component dimensions production tolerance complying DIN IEC 286-3

All dimensions in millimeters unless otherwise stated

Enclosure Type	Tape Width W (mm)	Quantity per meter	Quantity per reel	Dimension P
G194	32		500	20

Recommended Reflow Profile

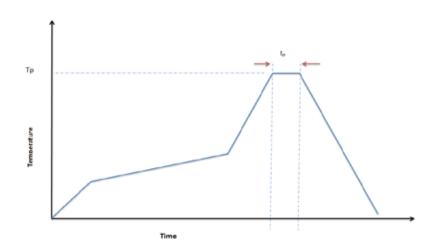
TP: max 250°C (@ solder joint, customer board level)

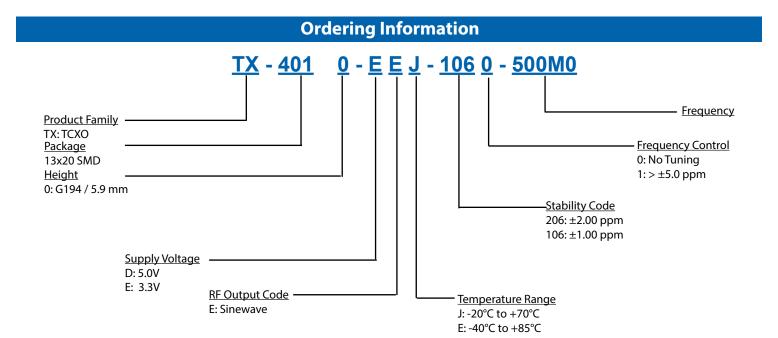
T_p: max: 10...30 sec

Additional Information:

This SMD oscillator has been designed for pick and place reflow soldering

SMD oscillators must be on the top side of the PCB during the reflow process.





Notes:

- 1. Contact factory for improved stabilities or additional product options. Not all options and codes are available at all frequencies.
- 2. Phase noise degrades with increasing output frequency.
- 3. Contact factory for availability.

Unless other stated all values are valid at typical conditions for supply voltage, frequency control voltage, load, temperature (25°C). Subject to technical modification.



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